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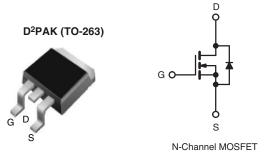
COMPLIANT

HALOGEN FREE



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	$V_{GS} = 5.0 V$	0.028			
Q _g (Max.) (nC)	66				
Q _{gs} (nC)	12				
Q _{gd} (nC)	43				
Configuration	Single				



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION		
Package	D ² PAK (TO-263)	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHLZ44S-GE3	SiHLZ44STRR-GE3ª
Lead (Pb)-free	IRLZ44SPbF	IRLZ44STRRPbF ^a
	SiHLZ44S-E3	SiHLZ44STR-E3 ^a

Note a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	60	v		
Gate-Source Voltage			V _{GS}	± 10	v		
Continuous Drain Current ^f	V _{GS} at 5.0 V	T _C = 25 °C	1	50	А		
Continuous Drain Current	V _{GS} at 5.0 V	T _C = 100 °C	I _D	36			
Pulsed Drain Current ^a			I _{DM}	200			
Linear Derating Factor				1.0	- W/°C		
Linear Derating Factor (PCB Mount) ^e				0.025			
Single Pulse Avalanche Energy ^b			E _{AS}	400	mJ		
Maximum Power Dissipation	T _C = 25 °C		Р	150	w		
Maximum Power Dissipation (PCB Mount)e	$T_A =$	25 °C	P _D	3.7			
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	**		
Soldering Recommendations (Peak Temperature) ^d	for 1	10 s	-	300 ^d	- °C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, $L = 179 \text{ }\mu\text{H}$, $R_g = 25 \Omega$, $I_{AS} = 51 \text{ A}$ (see fig. 12). c. $I_{SD} \le 51 \text{ A}$, dl/dt $\le 250 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \text{ °C}$.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

f. Current limited by the package, (die current = 51 A).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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d. 1.6 mm from case.



THERMAL RESISTANCE RATI		TYP					LINUT		
PARAMETER	SYMBOL	TYP		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 62							
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	- 40			°C/W				
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.0							
lote . When mounted on 1" square PCB (FR-4 o	or G-10 material).							
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	vise noted)							
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static		•						•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0, I _D = 25	0 μΑ	60	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.070	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			1.0	-	2.0	V	
Gate-Source Leakage	I _{GSS}	Ň	/ _{GS} = ± 10 '	V	-	-	± 100	nA	
		V _{DS} =	= 60 V, V _{GS}	= 0 V	-	-	25	μA	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 48 V,	$V_{GS} = 0 V,$	T _J = 150 °C	-	-	250		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 5.0 V		= 31 A ^b	-	-	0.028		
		V _{GS} = 4.0 V		= 25 A ^b	-	-	0.039	Ω	
Forward Transconductance	g _{fs}	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 31 \text{ Ab}$		23	-	-	S		
Dynamic	0.0							I	
Input Capacitance	C _{iss}				-	3300	-		
Output Capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		_	1200	_	pF		
Reverse Transfer Capacitance	C _{rss}		0 MHz, see		-	200	_	р ¹	
Total Gate Charge	Qg				_	-	66		
Gate-Source Charge	Q _{gs}	$V_{GS} = 5.0 \text{ V} \qquad \begin{array}{c} I_{D} = 51 \text{ A}, V_{DS} = 48 \text{ V},\\ \text{see fig. 6 and } 13^{\text{b}} \end{array}$			_	_	12	nC	
Gate-Drain Charge	Q _{gd}			J. 6 and 13 ^b	_	_	43		
Turn-On Delay Time		V_{DD} = 30 V, I _D = 51 A, R _g = 4.6 Ω, R _D = 0.56 Ω, see fig. 10 ^b			_	17	-		
Rise Time	t _{d(on)} t _r				230	_	- ns		
Turn-Off Delay Time					42	_			
Fall Time	t _{d(off)}			_		_			
	t _f	Between lead,		D	-	110	-	<u> </u>	
Internal Drain Inductance	L _D	6 mm (0.25") f			-	4.5	-		
Internal Source Inductance	Ls	package and center of			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s				•	•			
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	50°	A		
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode			-	-		200	
Body Diode Voltage	V _{SD}	T_J = 25 °C, I_S = 51 A, V_{GS} = 0 V ^b			-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}			-	130	180	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	- T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/µs ^b			-	0.84	1.3	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is				ninated h	vlaand	1-2)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 μs; duty cycle ≤ 2 %.
c. Current limited by the package, (Die Current = 51 A).

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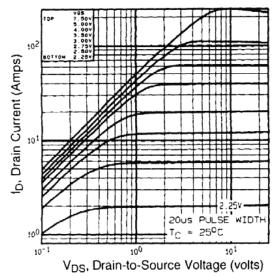


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

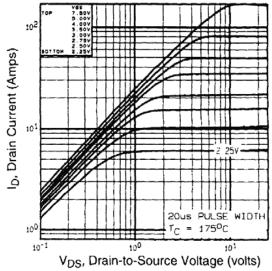
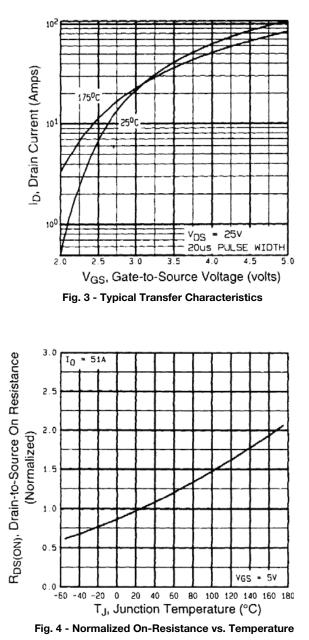


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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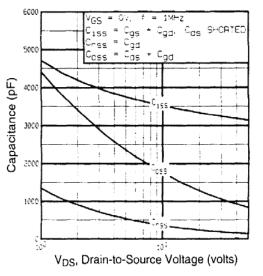


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

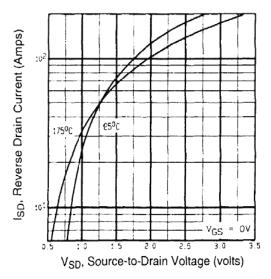


Fig. 7 - Typical Source-Drain Diode Forward Voltage

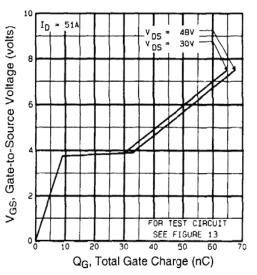
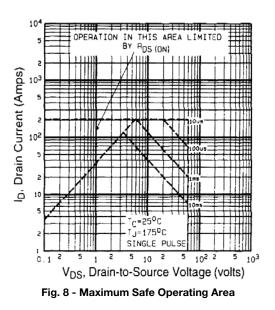


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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IRLZ44S, SiHLZ44S

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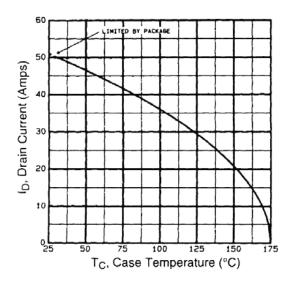


Fig. 9 - Maximum Drain Current vs. Case Temperature

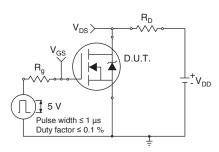


Fig. 10a - Switching Time Test Circuit

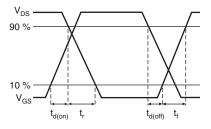


Fig. 10b - Switching Time Waveforms

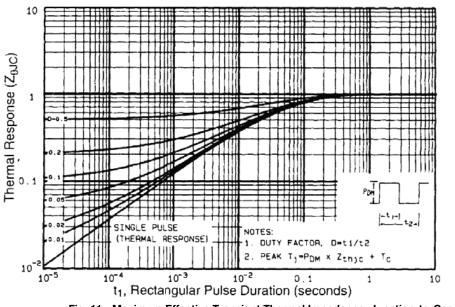


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



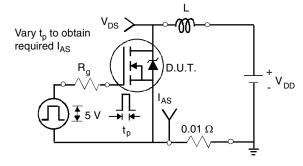


Fig. 12a - Unclamped Inductive Test Circuit

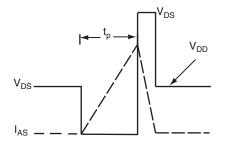


Fig. 12b - Unclamped Inductive Waveforms

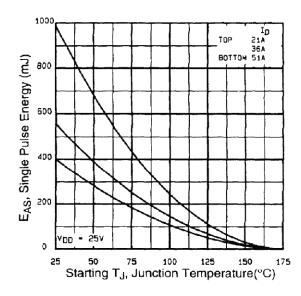
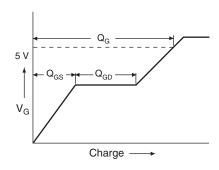
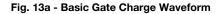


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





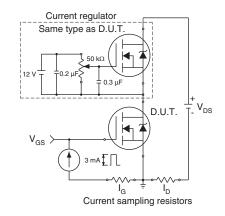


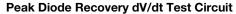
Fig. 13b - Gate Charge Test Circuit

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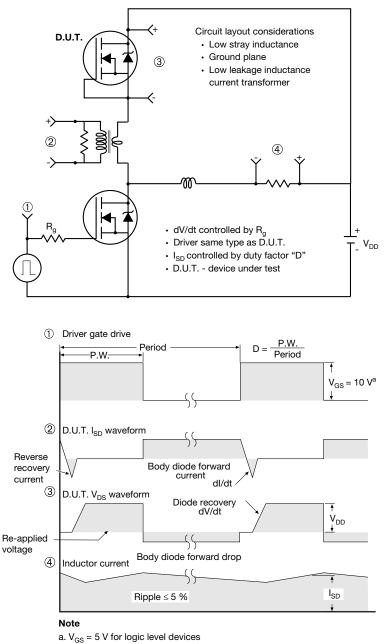


Fig. 14 - For N-Channel

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